

CY7C1049CV33 Automotive 4-Mbit (512 K × 8) Static RAM

Features

- Temperature ranges
 Automotive -A: -40 °C to 85 °C
 Automotive-E: -40 °C to 125 °C
- High speed □ t_{AA} = 10 ns
- Low active power □ 360 mW (max)
- 2.0 V data retention
- Automatic power down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with CE and OE features

Functional Description

The CY7C1049CV33 Automotive is a high performance CMOS Static RAM organized as 524,288 words by eight bits. Easy memory expansion is provided by an active LOW Chip Enable (\overline{CE}), an active LOW Output Enable (\overline{OE}), and three-state drivers. <u>Wri</u>ting to the device is <u>accomplished by taking Chip Enable (\overline{CE}) and Write Enable (\overline{WE}) inputs LOW. Data on the eight I/O pins (I/O₀ through I/O₇) is then written into the location specified on the address pins (A₀ through A₁₈).</u>

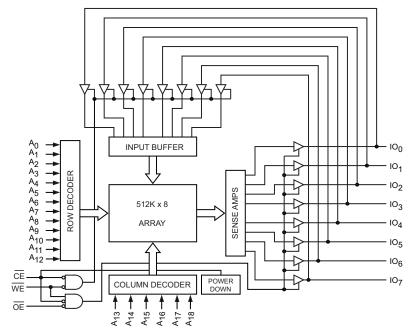
Reading from the device is accomplished by taking Chip Enable (\overline{CE}) and Output Enable (\overline{OE}) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins appear on the I/O pins.

The eight input and output pins $(I/O_0 \text{ through } I/O_7)$ are placed in a high impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation (CE LOW, and WE LOW).

The CY7C1049CV33 Automotive is available in standard 400-mil-wide 36-pin SOJ package and 44-pin TSOP II package with center power and ground (revolutionary) pinout.

For best practice recommendations, refer to the Cypress application note AN1064, SRAM System Guidelines.

Logic Block Diagram





CY7C1049CV33 Automotive

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Selection Guide

Description		-10	-12	-15	Unit
Maximum Access Time		10	12	15	ns
Maximum Operating Current	Automotive-A	100	95	-	mA
	Automotive-E	-	-	95	mA
Maximum CMOS Standby Current	Automotive-A	10	10	-	mA
	Automotive-E	-	-	15	mA

Pin Configuration

Figure 1. 36-pin SOJ (Top View)

1		
A ₀	10	36 🗌 NC
A ₁	2	35 🗌 A ₁₈
A ₂	3	34 🗌 A ₁₇
A ₃	4	33 🗌 A ₁₆
A ₄	5	32 🗌 A ₁₅
CE	6	31 🗌 🔂
I/O ₀	7	30 🗌 I/O7
I/O ₁ □	8	29 I/O ₆
V _{CC}	9	28 GND
GND 🗌	10	27 🗌 V _{CC}
I/O ₂ □	11	26 🗍 I/Õ ₅
I/O ₃	12	25 I/O ₄
WE	13	24 🗌 A ₁₄
A ₅ [14	23 🗌 A ₁₃
A ₆	15	22 🗌 A ₁₂
A ₇ [16	21 🛛 A ₁₁
A ₈	17	20 🗌 A ₁₀
A ₉	18	19 🗌 NC

Figure 2. 44-pin TSOP II (Top View)

NC NC A ₀ L A ₁ L A ₂ L	1 2 3 4 5 6	44 43 42 41 40 39	NC NC NC A ₁₈ A ₁₇ A ₁₆
A1E 001 V V SS 2 3 V V V V V V V V V V V V V V V V V V V	7 8 9 10 11 12 13 14 15 16 17 18	38 37 36 35 34 33 32 31 30 29 28 27	$ \begin{array}{c} A_{15} \\ OE \\ I \\ OE \\ I \\ OE \\ I \\ O_7 \\ I \\ O_6 \\ V_{SS} \\ V_{CC} \\ I \\ O_5 \\ I \\ O_4 \\ I \\ A_{14} \\ A_{13} \\ A_{12} \\ A_{11} \\ A_{12} \\ A_{11} \\ A_{12} \\ $
A ₈ A ₉ NC NC	19 20 21 22	26 25 24 23	A11 A10 NC NC NC NC

Pin Definitions

Pin Name	36 SOJ Pin Number	44 TSOP II Pin Number	I/O Type	Description
A ₀ -A ₁₈	1–5, 14–18, 20–24, 32–35	3–7, 16–20, 26–30, 38–41	Input	Address inputs used to select one of the address locations.
1/0 ₀ –1/0 ₇	7, 8, 11, 12, 25, 26, 29, 30	9, 10, 13, 14, 31, 32, 35, 36	Input/Output	Bidirectional data I/O lines. Used as input or output lines depending on operation
NC ^[1]	19, 36	1, 2, 21, 22, 23, 24, 25, 42, 43, 44	No Connect	No connects. This pin is not connected to the die
WE	13	15	Input/Control	Write Enable input, active LOW. When selected LOW, a WRITE is conducted. When selected HIGH, a READ is conducted.
CE	6	8	Input/Control	Chip Enable input, active LOW. When LOW, selects the chip. When HIGH, deselects the chip.
OE	31	37	Input/Control	Output Enable, active LOW. Controls the direction of the I/O pins. When LOW, the I/O pins are allowed to behave as outputs. When deasserted HIGH, I/O pins are three-stated, and act as input data pins.
V _{SS} , GND	10, 28	12, 34	Ground	Ground for the device. Should be connected to ground of the system.
V _{CC}	9, 27	11, 33	Power Supply	Power supply inputs to the device.

Note

1. NC pins are not connected on the die.



Maximum Ratings

Exceeding maximum ratings may impair the useful life of the device. These user guidelines are not tested.

Storage Temperature	–65 °C to +150 °C
Ambient Temperature with	
Power Applied	–55 °C to +125 °C
Supply Voltage on V _{CC} to Relative GND ^[2]	L_0.5 V to +4.6 VDC

Voltage Applied to Outputs	
in High Z State ^[2]	–0.5 V to V _{CC} + 0.5 V
Input Voltage ^[2]	–0.5 V to V _{CC} + 0.5 V
Current into Outputs (LOW)	

Operating Range

Range	Ambient Temperature	V _{cc}
Automotive-A	–40 °C to +85 °C	$3.3~V\pm0.3~V$
Automotive-E	–40 °C to +125 °C	

Electrical Characteristics

Over the Operating Range

Parameter	Description	Test Conditions		-1	0	-1	2	-1	5	Unit
Falameter	Description	Test conditions		Min	Max	Min	Max	Min	Max	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min; I _{OH} = -4.0 mA		2.4	_	2.4	-	2.4	_	V
V _{OL}	Output LOW Voltage	V _{CC} = Min; I _{OL} = 8.0 mA		-	0.4	-	0.4	-	0.4	V
V _{IH}	Input HIGH Voltage			2.0	V _{CC} + 0.3	2.0	V _{CC} + 0.3	2.0	V _{CC} + 0.3	V
V _{IL}	Input LOW Voltage ^[2]			-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I _{IX}	Input Load Current	$GND \leq V_I \leq V_{CC}$	Auto-A	-1	+1	-1	+1	-	_	μA
			Auto-E	-	—	-	_	-20	+20	
I _{CC}	V _{CC} Operating Supply Current	V _{CC} = Max, f = f _{MAX} = 1/t _{RC}	Auto-A	-	100	-	95	-	—	mA
			Auto-E	-	—	-	_	-	95	
I _{SB1}		Max. V _{CC} , <u>CE ≥</u> V _{IH} ;	Auto-A	-	40	-	40	-	-	mA
	Power Down Current —TTL Inputs	$V_{IN} \ge V_{IH}$ or $V_{IN} \le V_{IL}$, f = f _{MAX}	Auto-E	-	-	Ι	-	Ι	45	mA
I _{SB2}		Max. V_{CC} , $\overline{CE} \ge V_{CC} - 0.3 V$,	Auto-A	-	10	-	10	-	_	mA
		$V_{IN} \ge V_{CC} - 0.3 \text{ V}, \text{ or } V_{IN} \le 0.3 \text{ V}, f = 0$	Auto-E	-	-	-	-	-	15	mA

Capacitance

Tested initially and after any design or process changes that may affect these parameters.

Parameter ^[3]	Description	Test Conditions	Max	Unit
C _{IN}	Input Capacitance	T _A = 25 °C, f = 1 MHz, V _{CC} = 3.3 V	8	pF
C _{OUT}	I/O Capacitance		8	pF

Thermal Resistance

Tested initially and after any design or process changes that may affect these parameters.

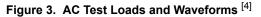
Parameter ^[3]	Description	Test Conditions	36-pin SOJ	44-pin TSOP-II	Unit
Θ_{JA}	· /	Test conditions follow standard test methods and procedures for	46.51	41.66	°C/W
Θ_{JC}		measuring thermal impedance, per EIA / JESD51.	18.8	10.56	°C/W

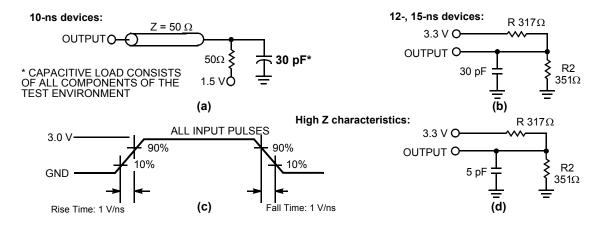
Notes

V_{IL} (min) = -2.0 V and V_{IH}(max) = V_{CC} + 0.5 V for pulse durations of less than 20 ns.
 Tested initially and after any design or process changes that may affect these parameters.









Notes

AC characteristics (except High Z) for 10 ns parts are tested using the load conditions shown in Figure 3 (a). All other speeds are tested using the Thevenin load shown in Figure 3 (b). High Z characteristics are tested for all speeds using the test load shown in Figure 3 (d).



AC Switching Characteristics

Over the Operating Range [5]

		-10		-12		-15		
Parameter	Description	Min	Max	Min	Мах	Min	Max	Unit
Read Cycle								
t _{power} [6]	V _{CC} (typical) to the first access	100	_	100	-	100	-	μS
t _{RC}	Read Cycle Time	10	-	12	-	15	-	ns
t _{AA}	Address to Data Valid	-	10	-	12	-	15	ns
t _{OHA}	Data Hold from Address Change	3	-	3	-	-	3	ns
t _{ACE}	CE LOW to Data Valid	-	10	-	12	-	15	ns
t _{DOE}	OE LOW to Data Valid	-	5	-	6	-	7	ns
t _{LZOE}	OE LOW to Low Z	0	_	0	_	0	_	ns
t _{HZOE}	OE HIGH to High Z ^[7, 8]	_	5	-	6	_	7	ns
t _{LZCE}	CE LOW to Low Z ^[8]	3	_	3	_	3	_	ns
t _{HZCE}	CE HIGH to High Z ^[7, 8]	_	5	-	6	_	7	ns
t _{PU}	CE LOW to Power Up	0	_	0	_	0	_	ns
t _{PD}	CE HIGH to Power Down	_	10	-	12	_	15	ns
Write Cycle ^{[§}	9, 10]		•					
t _{WC}	Write Cycle Time	10	-	12	-	15	-	ns
t _{SCE}	CE LOW to Write End	7	-	8	-	10	-	ns
t _{AW}	Address Setup to Write End	7	-	8	-	10	-	ns
t _{HA}	Address Hold from Write End	0	-	0	-	0	-	ns
t _{SA}	Address Setup to Write Start	0	-	0	-	0	-	ns
t _{PWE}	WE Pulse Width	7	-	8	-	10	-	ns
t _{SD}	Data Setup to Write End	5	-	6	-	7	-	ns
t _{HD}	Data Hold from Write End	0	-	0	-	0	-	ns
t _{LZWE}	WE HIGH to Low Z ^[8]	3	-	3	-	3	-	ns
t _{HZWE}	WE LOW to High Z ^[7, 8]	-	5	-	6	-	7	ns

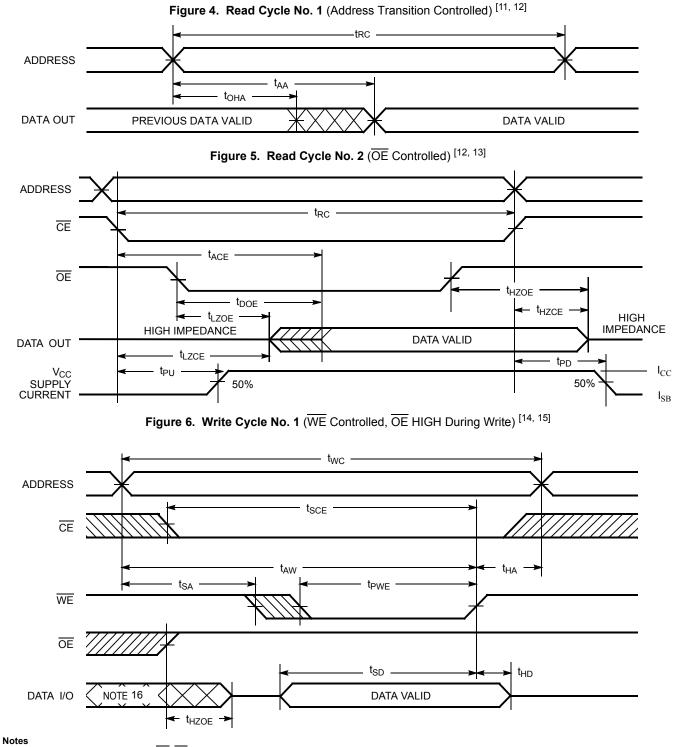
Notes

5. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V, input pulse levels of 0 to 3.0 V.

1. Jest conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V, input puise levels of 0.0 0.0 V.
 t_{POWER} gives the minimum amount of time that the power supply should be at stable, typical V_{CC} values until the first memory access can be performed.
 t_{HZCE}, t_{HZCE}, and t_{HZWE} are specified with a load capacitance of 5 pF as in part (d) of Figure 3 on page 5. Transition is measured ±500 mV from steady-state voltage.
 At any temperature and voltage condition, t_{HZCE} is less than t_{LZOE}, t_{HZCE} and t_{HZWE} is less than t_{LZVE} for any device.
 The internal Write time of the memory is defined by the overlap of CE LOW, and WE LOW. CE and WE must be LOW to initiate a Write, and the transition of either of these signals can terminate the Write. The input data setup and hold timing should be referenced to the leading edge of the signal that terminates the Write.
 The minimum Write cycle time for Write Cycle No. 3 (WE controlled, OE LOW) is the sum of t_{HZWE} and t_{SD}.



Switching Waveforms



11. Device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$. 12. WE is HIGH for read cycles.

- 13. Address valid before or similar to \overline{CE} transition LOW.

14. Data I/O is high impedance if $\overline{OE} = V_{IH}$. 15. If \overline{OE} goes HIGH simultaneously with WE HIGH, the output remains in high impedance state.

16. During this period, the I/Os are in output state. Do not apply input signals.



Switching Waveforms (continued)

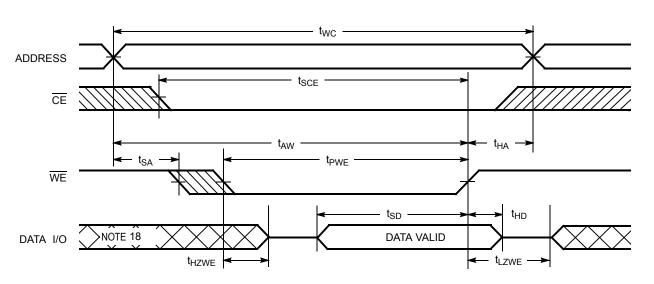


Figure 7. Write Cycle No. 2 (WE Controlled, OE LOW) ^[17]

Truth Table

CE	OE	WE	I/O ₀ –I/O ₇	Mode	Power
Н	Х	Х	High Z	Power Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I _{CC})

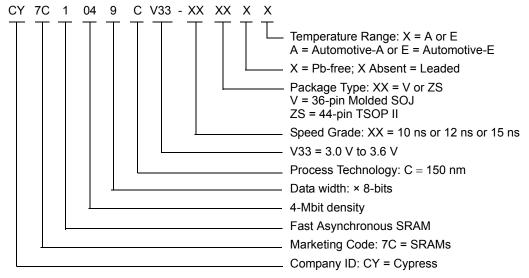
Notes______ 17. If $\overrightarrow{\text{CE}}$ goes HIGH simultaneously with $\overrightarrow{\text{WE}}$ HIGH, the output remains in high impedance state. 18. During this period, the I/Os are in output state. Do not apply input signals.



Ordering Information

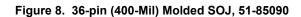
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
10	CY7C1049CV33-10VXA	51-85090	36-pin (400-Mil) Molded SOJ (Pb-free)	Automotive-A
12	CY7C1049CV33-12ZSXA	51-85087	44-pin TSOP II (Pb-free)	Automotive-A
15	CY7C1049CV33-15VXE	51-85090	36-pin (400-Mil) Molded SOJ (Pb-free)	Automotive-E
	CY7C1049CV33-15ZSXE	51-85087	44-pin TSOP II (Pb-free)	Automotive-E

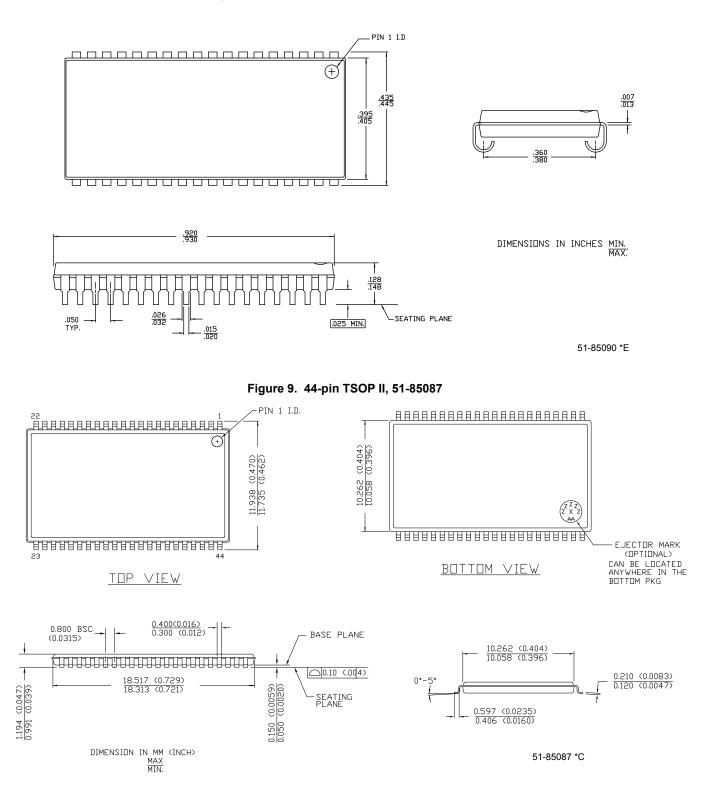
Ordering Code Definitions





Package Diagrams





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Acronyms

Acronym	Description		
CMOS	complementary metal oxide semiconductor		
CE	Chip Enable		
OE	Output Enable		
RAM	Random Access Memory		
I/O	Input/Output		
SOJ	small outline J-lead		
TTL	transistor-transistor logic		
TSOP	thin small outline package		
WE	Write Enable		

Document Conventions

Units of Measure

Symbol	Unit of Measure
Ω	ohms
ns	nano seconds
V	Volts
μs	micro seconds
μA	micro Amperes
mA	milli Amperes
mm	milli meter
ms	milli seconds
MHz	Mega Hertz
pF	pico Farad
%	percent
mW	milli Watts
W	Watts
°C	degree Celcius



Document History Page

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Rev.	ECN	Orig. of Change	Submission Date	Description of Change		
**	3186792	PRAS		Separation of the automotive datasheet from CY7C1049CV33 spec no. 38-05006 Rev. *J. Further rev of 38-05006 would include only industrial / commercial parts.		



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